



Product Change Notification

Change Notification #: 119545-00

Change Title: Select Intel® Server Boards, Spares and Accessories,
PCN 119545-00, Product Discontinuance,
End of life

Date of Publication: May 05, 2023

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins	May 05, 2023
Last Product Discontinuance Order Date	June 30, 2023
Orders are Non-Cancelable and Non-Returnable After	May 05, 2023
Last Product Discontinuance Shipment Date	December 22, 2023

Description of Change to the Customer:

Intel is announcing the discontinuance of the select Intel® Server Boards, Spares and Accessories listed in the "Products Affected/Intel Ordering Codes" table below.

Intel will make best efforts to support all orders placed between the Non-Cancelable and Non-Returnable (NCNR) and the Last Product Discontinuance Order (LPDO) dates. After the LPDO date existing inventory is still orderable, under NCNR terms, and will be filled on a first come first served basis. Deliveries must be accepted within 15 days from the system build date, or order placement date, whichever is later.

Final purchase orders are non-cancelable and non-returnable, notwithstanding any conflicting terms in our quotes, purchase order acknowledgement or Distributor agreements.

Intel has enabled MiTAC to manufacture and sell the discontinued DSG products. MiTAC is an edge-to-cloud IT solutions provider; has been a longstanding partner of DSG, and is the current DSG ODM, manufacturer, test, and integration partner for these systems. Intel and MiTAC are working together to ensure a smooth transition and to support you throughout this process. For information concerning these products, please email: DSGserverinfo@mitac.com or contact your Intel Authorized Distributor.

Engineering and Support Guidance for Discontinued Products:

1. Two Sustaining Cycle Releases¹ per year is planned during the Extended Life Period². Beginning 2026, this will reduce to One Sustaining Cycle Release per year.

¹ Sustaining Cycle Release includes new OS, peripheral, and adapter validation, bug fixes, IPU integration, and Critical PSIRTs integration are committed; High and lower PSIRTs at Intel's discretion

² Extended Life Period is defined as the period beginning with the Product Discontinuance Announcement publication date ("the PDA date") and continuing through the end of product warranty

2. No new features or enhancements should be expected, however ECOs may be required during the extended life period to maintain supply lines (e.g., to qualify new vendor due to a component EOL).
3. Intel will provide reasonable commercial efforts in debugging issues during the warranty period for the product after the PDA date has passed. Fixes cannot be committed, but Intel will endeavor to provide reasonable workarounds for the product.

Customer Impact of Change and Recommended Action:

Determine your remaining demand for this product and/or evaluate additional sources (if applicable).

Milestone dates are estimates and subject to change based on business and operational conditions.

For additional product information please contact: DSGServerInfo@mitac.com. Please contact your local Intel Distributor if you require more information or need assistance in selecting a replacement product.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	Affected MM#
I/O Breakout cable spare kit AXXCONNTDBG, Single	AXXCONNTDBG	999D47
EMP Module AXXFCEMP, Single	AXXFCEMP	999D48
1U Internal Rail Kit for Chassis (FC2000 Family) FCXX1USPPRT, Single	FCXX1USPPRT	999D4H
2U Chassis Fixed External Rail Kit FCXXRAILKIT, Single	FCXXRAILKIT	999D4J
Accelerator Card Kit TNPACCLBZDC, Single	TNPACCLBZDC	99A2AR
Liquid-Cooling Loop VR TIMM Application Tool TNPLCVRTLS, Single	TNPLCVRTLS	99AAKL
Liquid-Cooling Loop VR TIMM Compound TNPLCVRCMPD, Single	TNPLCVRCMPD	99AAKM
Liquid-Cooling Loop VR TIMM Application Nozzle TNPLCVRTNZ, Single	TNPLCVRTNZ	99AF47
Accelerator Card Kit TNPACCLBZA100, Single	TNPACCLBZA100	99AJJC
1U Air-Cooled Rear Heat Sink DNP1UHSB Single	DNP1UHSB	99ARJC
M.2 Liquid-Cooled Heat Sink DNPM2LCHS, Single	DNPM2LCHS	99ARJG
Chassis Liquid Cooling plumbing connection FCXXLCMDMFD, Single	FCXXLCMDMFD	99ARJR
Intel® Server Board D50DNP1SB, Single	D50DNP1SB	99ARWL
Intel® Server System D50DNP1MHCPAC Compute Module, Single	D50DNP1MHCPAC	99ARWP
Intel® Server System D50DNP1MHEVAC Compute Module, Single	D50DNP1MHEVAC	99ARWR
Intel® Server System D50DNP1MHCPLC Compute Module, Single	D50DNP1MHCPLC	99ARWT
Intel® Server System D50DNP2MHSVAC Management Module, Single	D50DNP2MHSVAC	99ARWV
Intel® Server System D50DNP1MFALLC Acceleration Module, Single	D50DNP1MFALLC	99ARWW
Intel® Server System D50DNP2MFALAC Acceleration Module, Single	D50DNP2MFALAC	99ARWX
CPU Carrier Clip (4th Gen Intel® Xeon® Scalable Processors) AXXSPRHBMcC, Single	AXXSPRHBMcC	99ARX1
Accelerator Card Kit DNPACCLBZPVC, Single	DNPACCLBZPVC	99ARX3
1U PCIe Riser DNP1URISER, Single	DNP1URISER	99ARX4
1U PCIe MCIO Riser DNP1UMRISER, Single	DNP1UMRISER	99ARX5

2U PCIe MCIO Riser DNP2UMRISER, Single	DNP2UMRISER	99ARX6
2U PCIe Accelerator Riser DNPACCLRISER1, Single	DNPACCLRISER1	99ARX7
2U PCIe Accelerator Riser DNPACCLRISER2, Single	DNPACCLRISER2	99ARX8
Accelerator Compute Module Connector Board DNPACCLCNBRD, Single	DNPACCLCNBRD	99ARX9
1U Air-Cooled front Heat Sink DNP1UHSF, Single	DNP1UHSF	99ARXA
2U Air-Cooled front Heat Sink DNP2UHSF, Single	DNP2UHSF	99ARXD
2U Air-Cooled Rear Heat Sink DNP2UHSB, Single	DNP2UHSB	99ARXF
1U Air-Cooled EVAC Heat Sink DNPEVACHS, Single	DNPEVACHS	99ARXH
Liquid-Cooling Loop DNPLCLPCM, Single	DNPLCLPCM	99ARXJ
Liquid-Cooling Loop PVC DNPLCLPAM (Accelerator Module), Single	DNPLCLPAM	99ARXK
M.2 Air-Cooled Heat Sink DNPM2HS, Single	DNPM2HS	99ARXM
Blank DIMM filler DNPDMMBLNK, 4 pack	DNPDMMBLNK	99ARXP
Liquid-Cooling Loop DIMM TIMM DNPLCDMTM, Single	DNPLCDMTM	99ARXR
Intel® Server Chassis FC2HAC27W0 Half-Width Configuration Air-Cooled No PSUs, Single	FC2HAC27W0	99ARXW
Intel® Server Chassis FC2FAC27W0 Full-Width Configuration Air-Cooled No PSUs, Single	FC2FAC27W0	99ARXZ
Intel® Server Chassis FC2HLC30W0 Half-Width Configuration Liquid-Cooled No PSUs, Single	FC2HLC30W0	99ARZ1
Intel® Server Chassis FC2FLC30W0 Full-Width Configuration Liquid-Cooled No PSUs, Single	FC2FLC30W0	99ARZ2
3000W Liquid-Cooled Power Supply FCXX30CRPSLC (FC2000 Family), Single	FCXX30CRPSLC	99ARZ3
Air-Cooled Power Supply Blank Filler FCXXBLANKAC (FC2000 Family), Single	FCXXBLANKAC	99ARZ4
Liquid-Cooled Power Supply Blank Filler FCXXBLANKLC (FC2000 Family), Single	FCXXBLANKLC	99ARZ5
Power Distribution Board FCXXPDBASSMBL2, Single	FCXXPDBASSMBL2	99ARZ7
Air-Cooled 40mm Fan Kit FCXX40MMACFAN, Single	FCXX40MMACFAN	99ARZ8
Liquid-Cooled 40mm Fan Kit FCXX40MMLCFAN, Single	FCXX40MMLCFAN	99ARZ9
Air-Cooled 60mm Fan Kit FCXX60MMACFAN, Single	FCXX60MMACFAN	99AT13
1U Compute Module Blank Node Full-Width Filler AXXFC1UFWBLANK, Single	AXXFC1UFWBLANK	99AT17
2700W Air-Cooled Power Supply FCXX27CRPSAC (FC2000 Family), Single	FCXX27CRPSAC	99AZAM
1U Compute Module Blank Node Half-Width Filler AXXFC1UHWBLANK, Single	AXXFC1UHWBLANK	99C0HF
Network Card Bracket kit (Acceleration Module) DNPACCLBZ810A, Single	DNPACCLBZ810A	99C212
Liquid-Cooling DIMM Clip and Mylar DNPLCDIMMCLIPM, Single	DNPLCDIMMCLIPM	99C654
Advanced System Management key ADVSYSMGMTKEY, Single	ADVSYSMGMTKEY	99AJX5

PCN Revision History:

Date of Revision:

May 05, 2023

Revision Number:

00

Reason:

Originally Published PCN



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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

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